

# **Search for Charged Particle Tracks Using CR-39 Detectors to Replicate the SPAWAR Pd/D External Field Co-Deposition Protocol**

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- Two cells (with & without magnets) – plastic **butyrate** rectangular cells, inch square
- Magnetic fields – approximately **2500 gauss** and **1 gauss** (+/- 40%) respectively at the cathodes
- Electrolyte – **0.03 M PdCl<sub>2</sub> + 0.3 M LiCl in D<sub>2</sub>O**, 22ml per cell
- Anode – **Pt wire** 0.25 mm diameter and immersed length several cm
- Cathode – **Ag wire** of 0.25 mm diameter and immersed length several cm
- Detector – **CR-39** (1 cm x 2 cm **Landauer/Fukuvi**)
- **Additional CR-39 detectors** (from **TASL**) were added outside the cells during the last 24 hours of electrolysis (at 100mA). Neutron detectors from **Landauer** (designed for dosimetry badges) were also added during the last days of the “loading” electrolysis phase.
- Before etch, electrolyzed CR-39 showed **SMALL** amounts of apparent Pd deposition on the CR-39 plastic track detector. CR-39 was rinsed to remove electrolyte but **NOT** wiped to remove the deposition. All CR-39 except the neutron detectors have been **etched 3 hours at about 68 deg C in 6.5 molar NaOH**.

# Cells with CR-39 under AG cathode wires before adding electrolyte

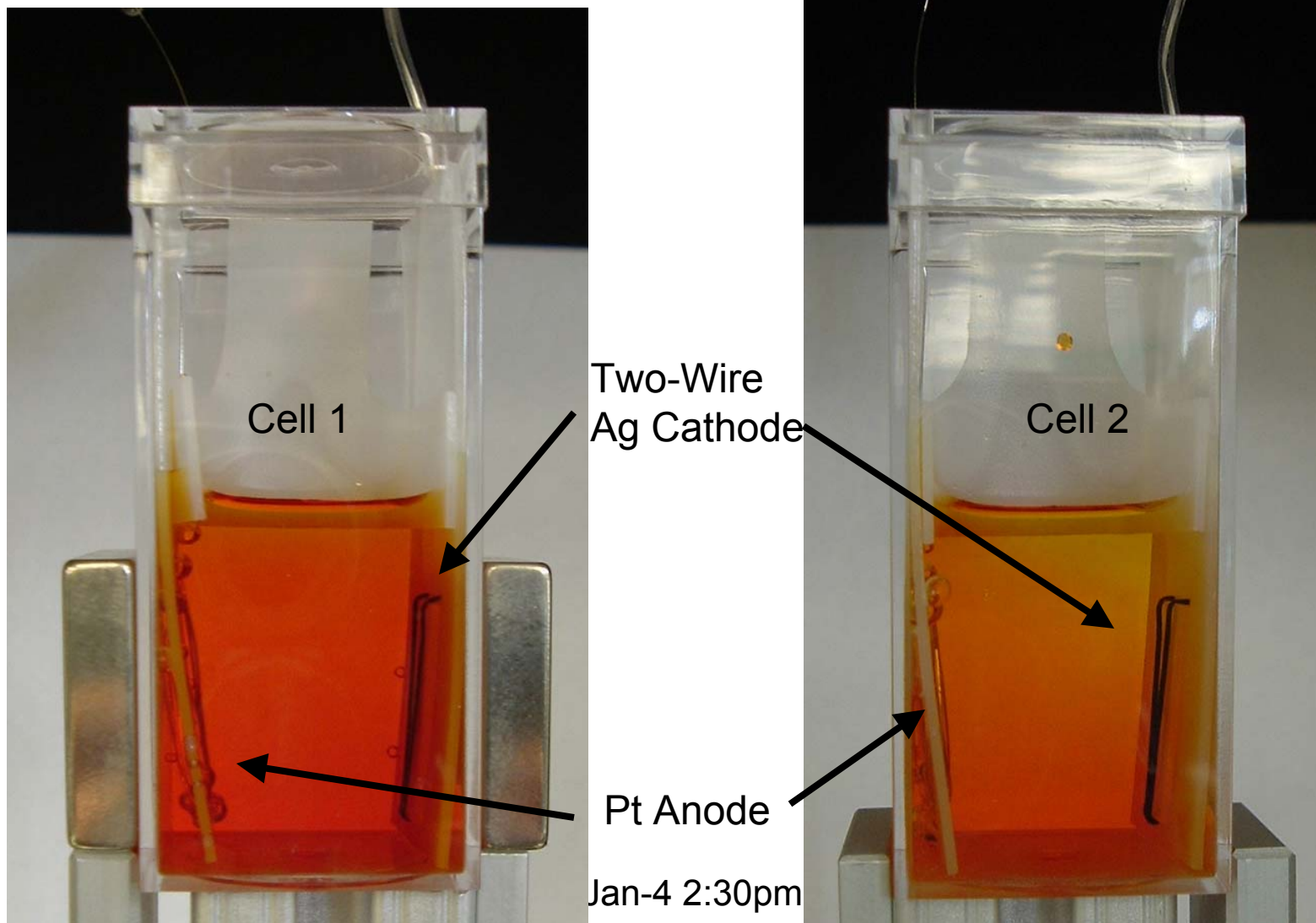
Cell 1



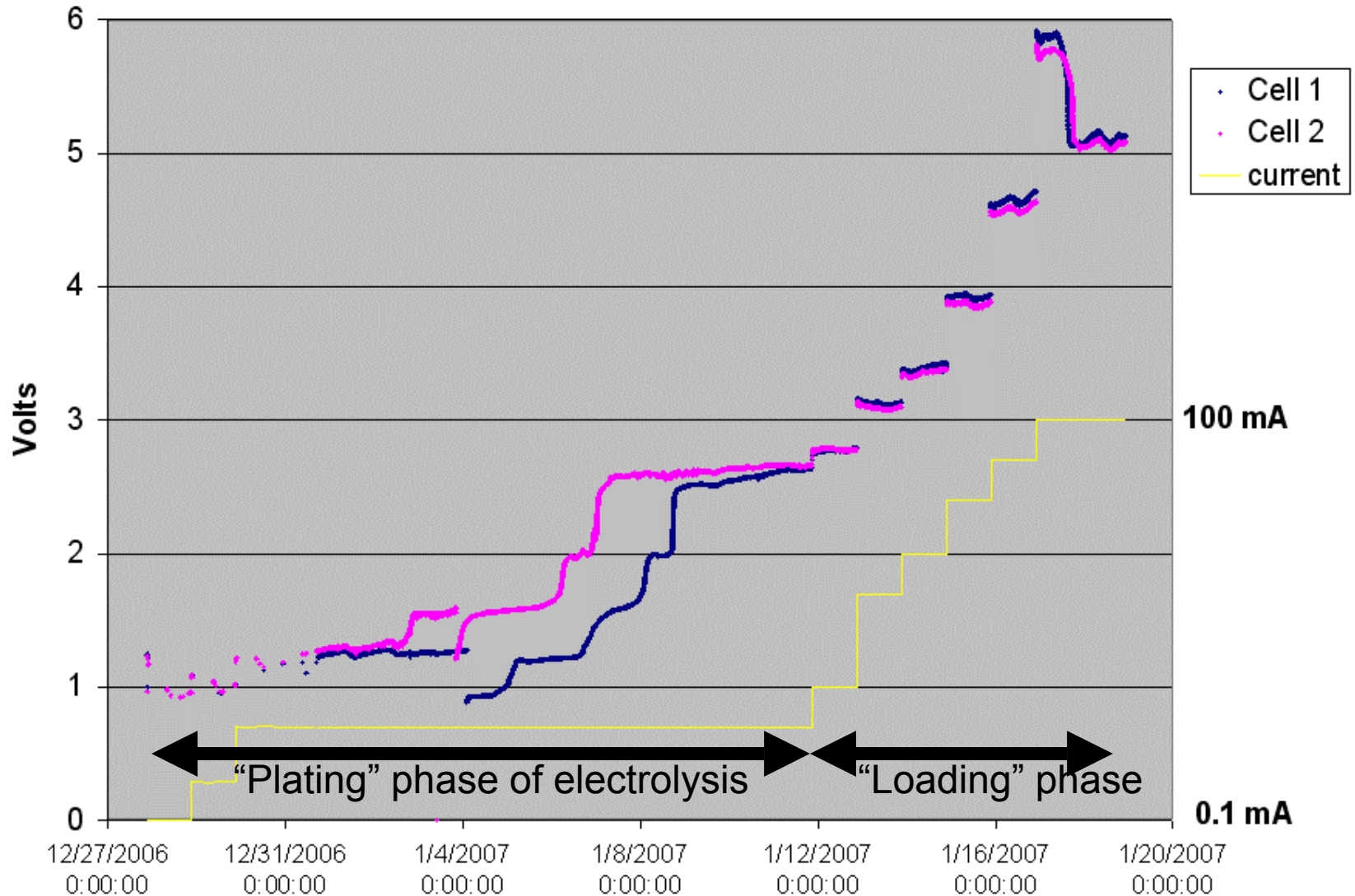
Cell 2



# Half way through “plating” phase of electrolysis

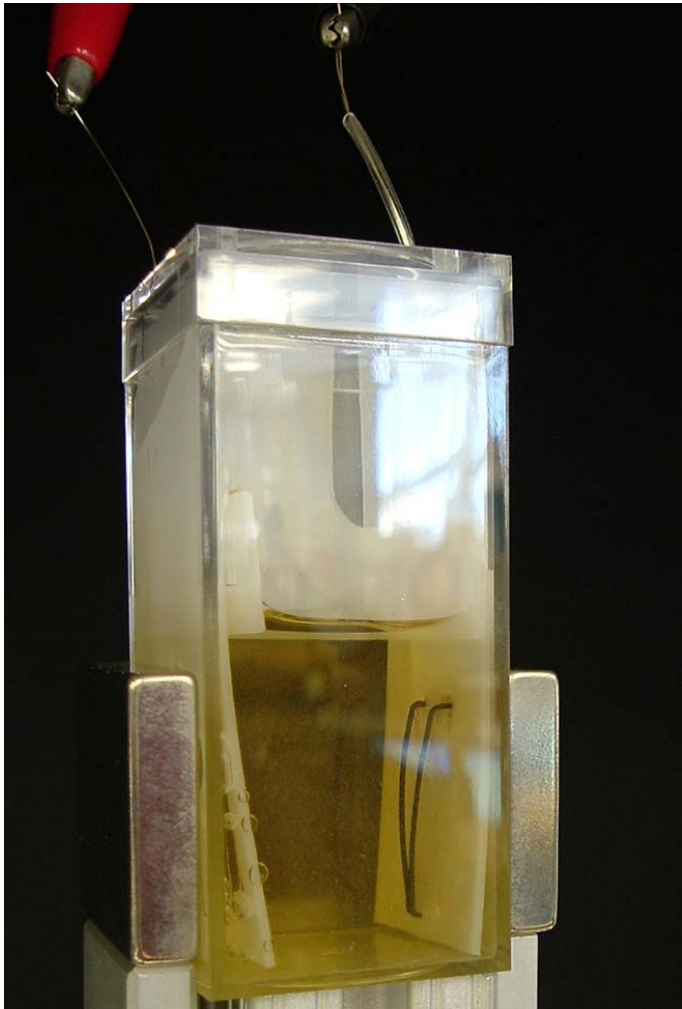


# Applied currents, and measured voltages across each cell during electrolysis

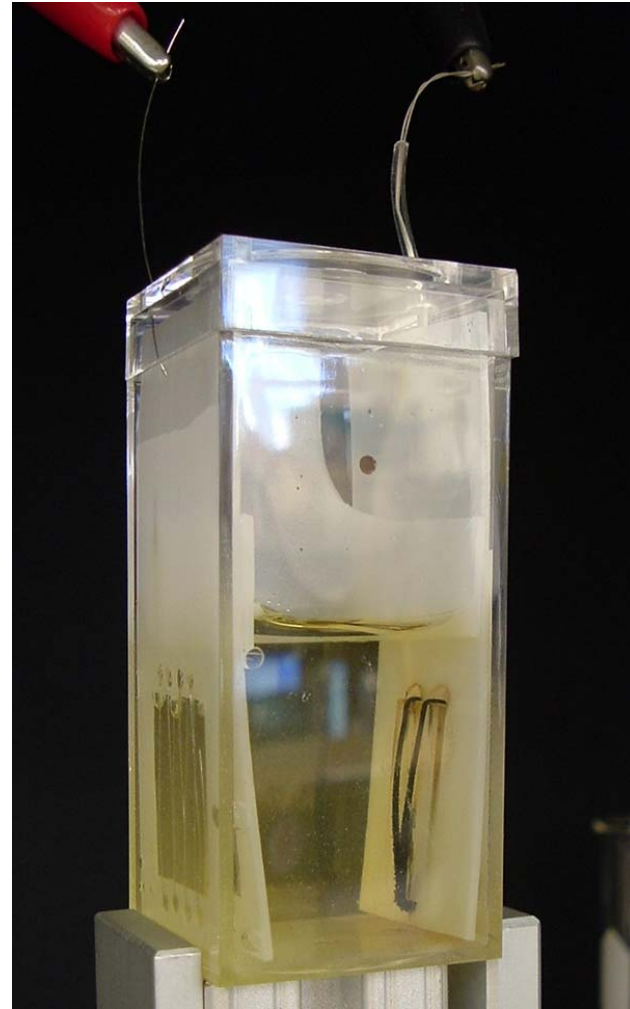


# “Plating” almost done

Cell 1



Cell 2



# “Plating” done



Cell 1

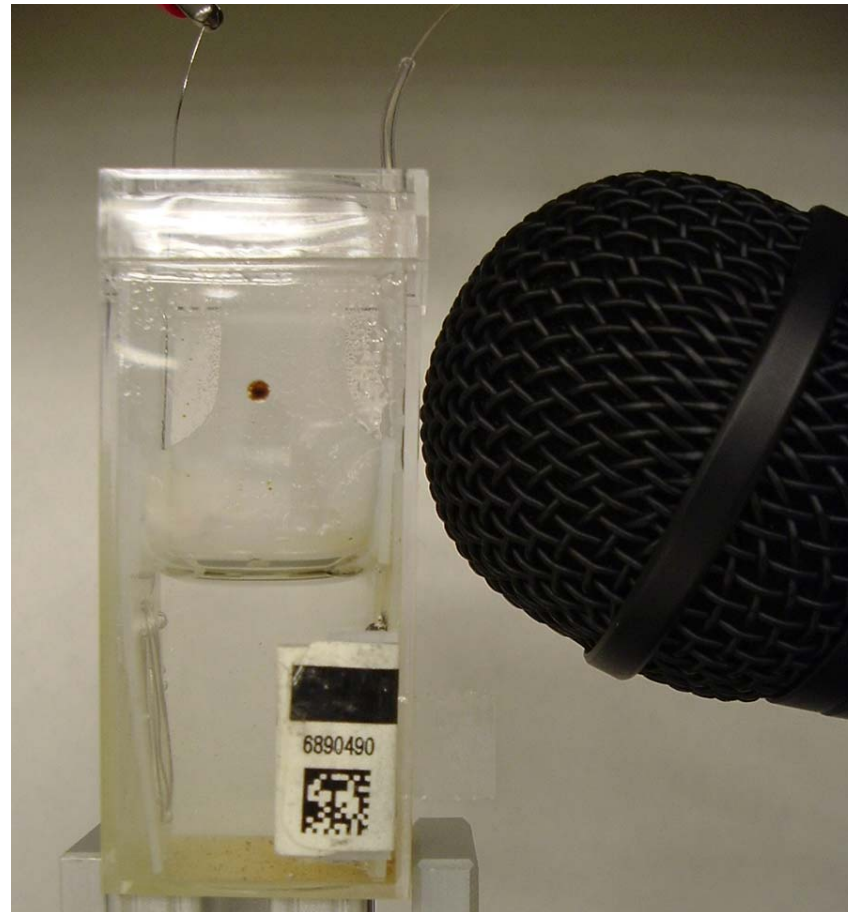


Cell 2

Jan-11 9:20am

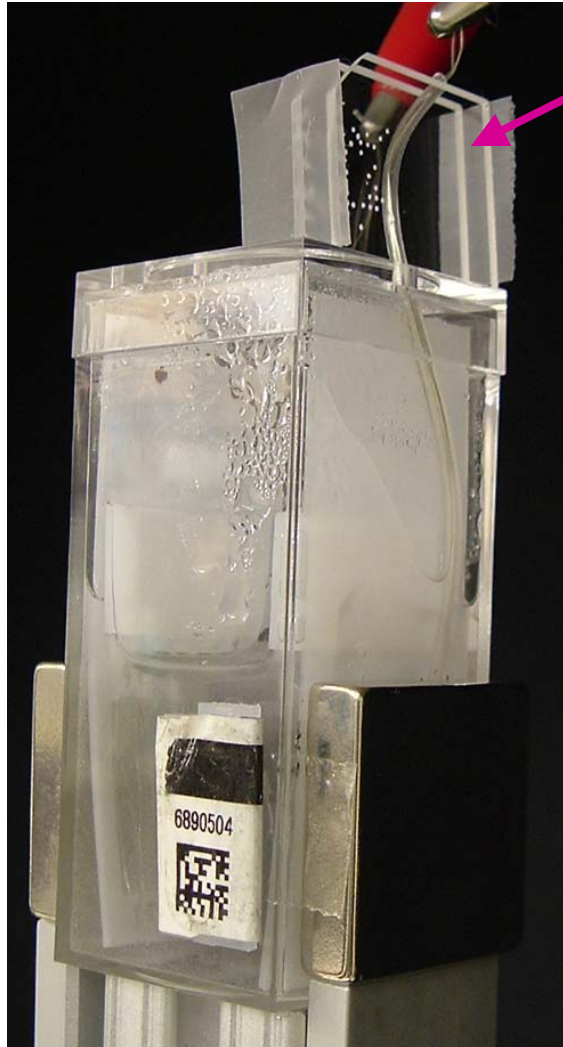
# Sounds recorded from Cell 2

Cell 2





# External CR-39 detectors added surrounding path of exit gas above cathodes



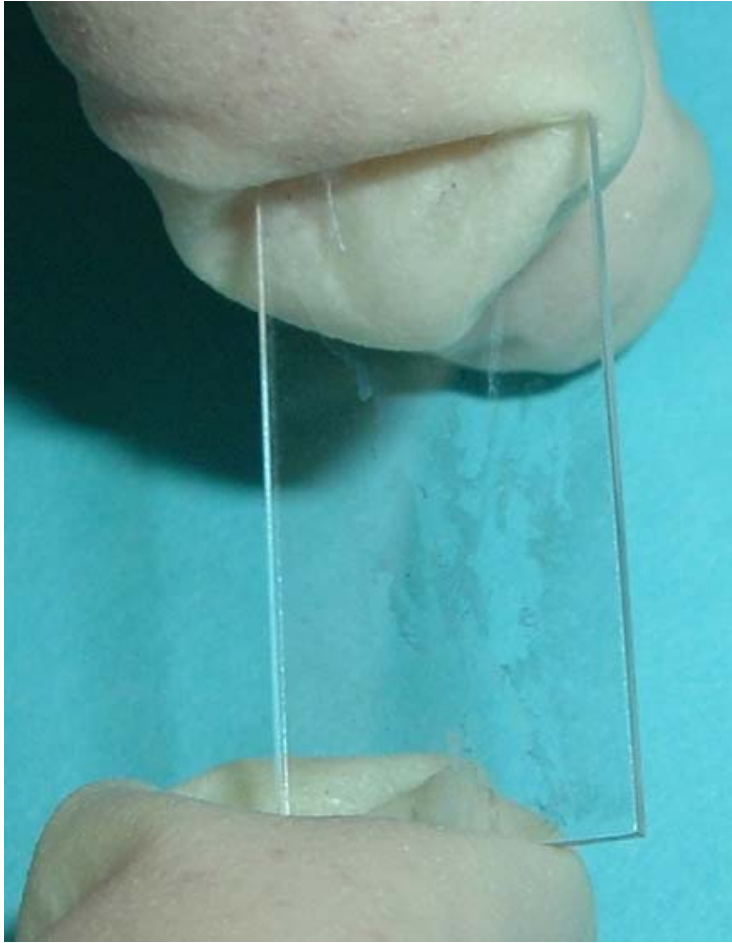
Cell1



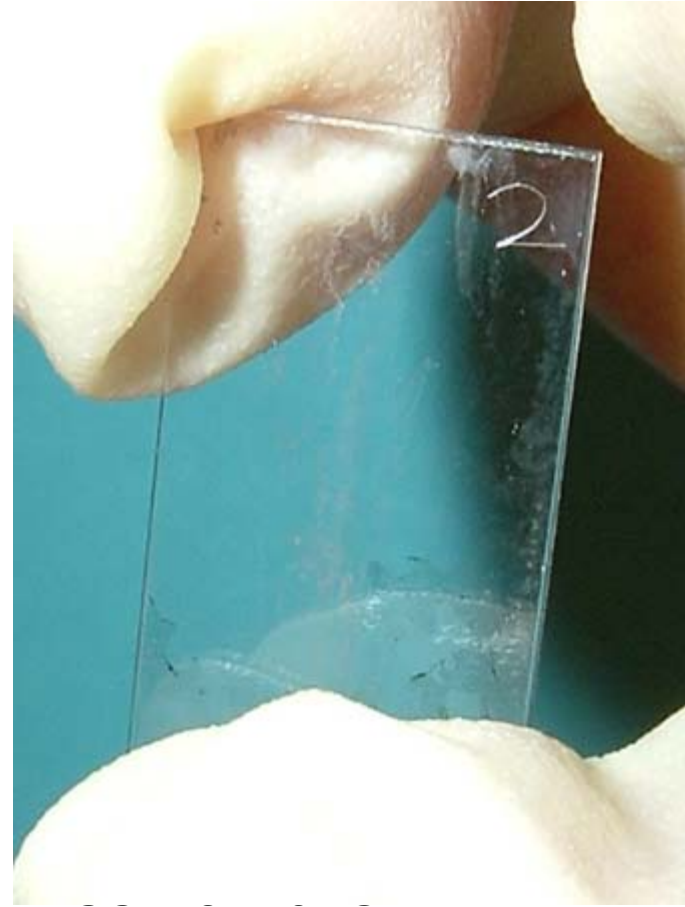
Cell2

Jan-17 9:30pm

# Electrolyzed CR-39 before etching

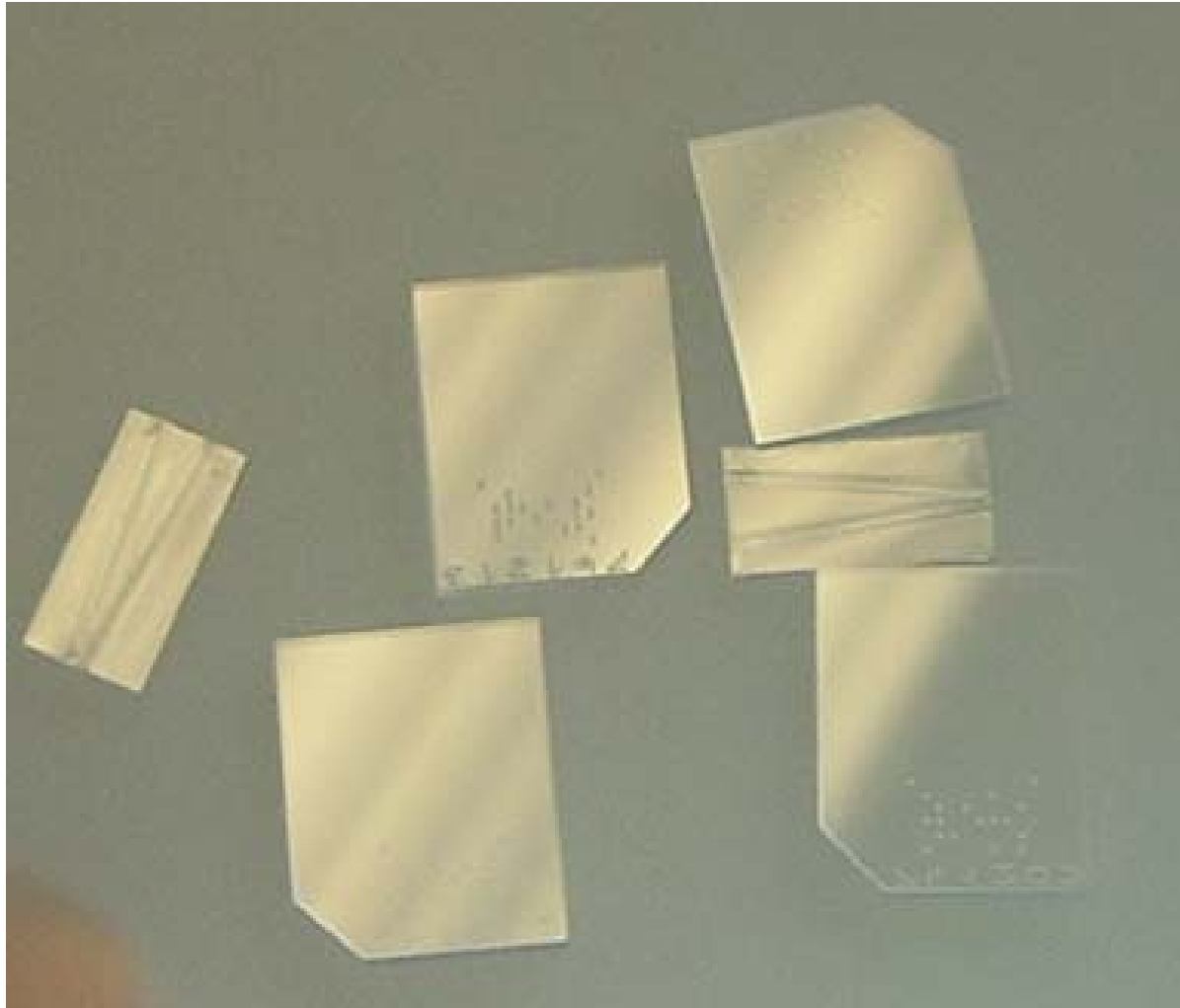


From Cell 1

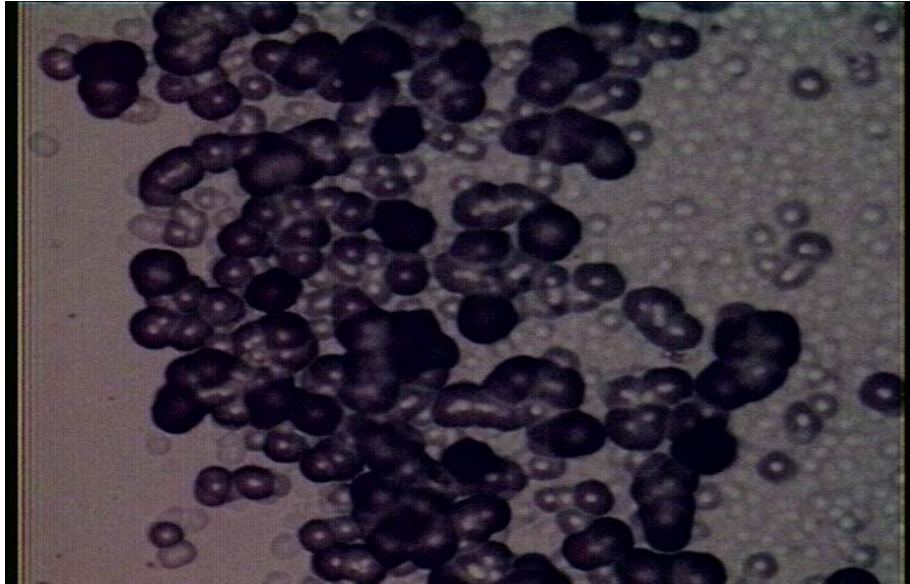


From Cell 2

CR-39 chips after etching 3 hours  
in 6.5 Normal NaOH at 68 deg C

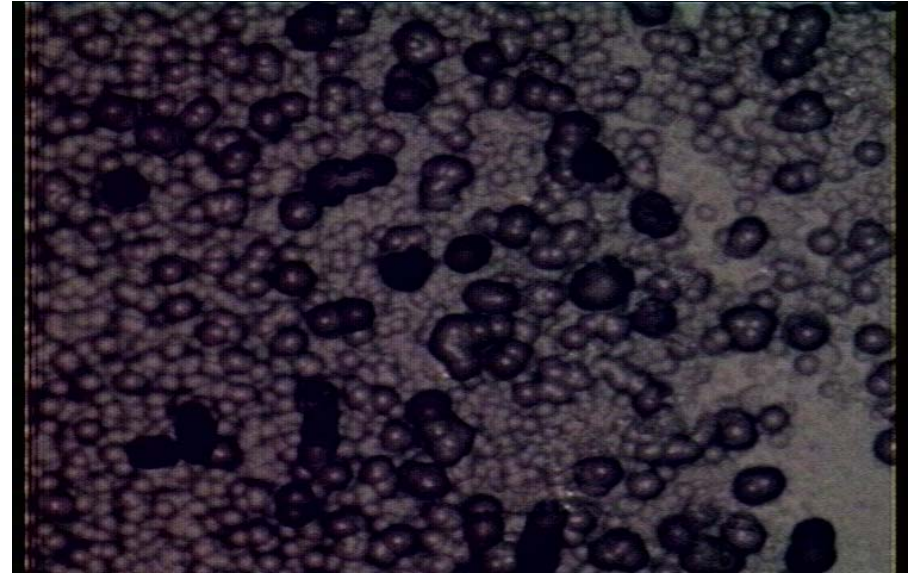


# Etchpits



Cathode side of Cell 1

BbottomGrWh.jpg

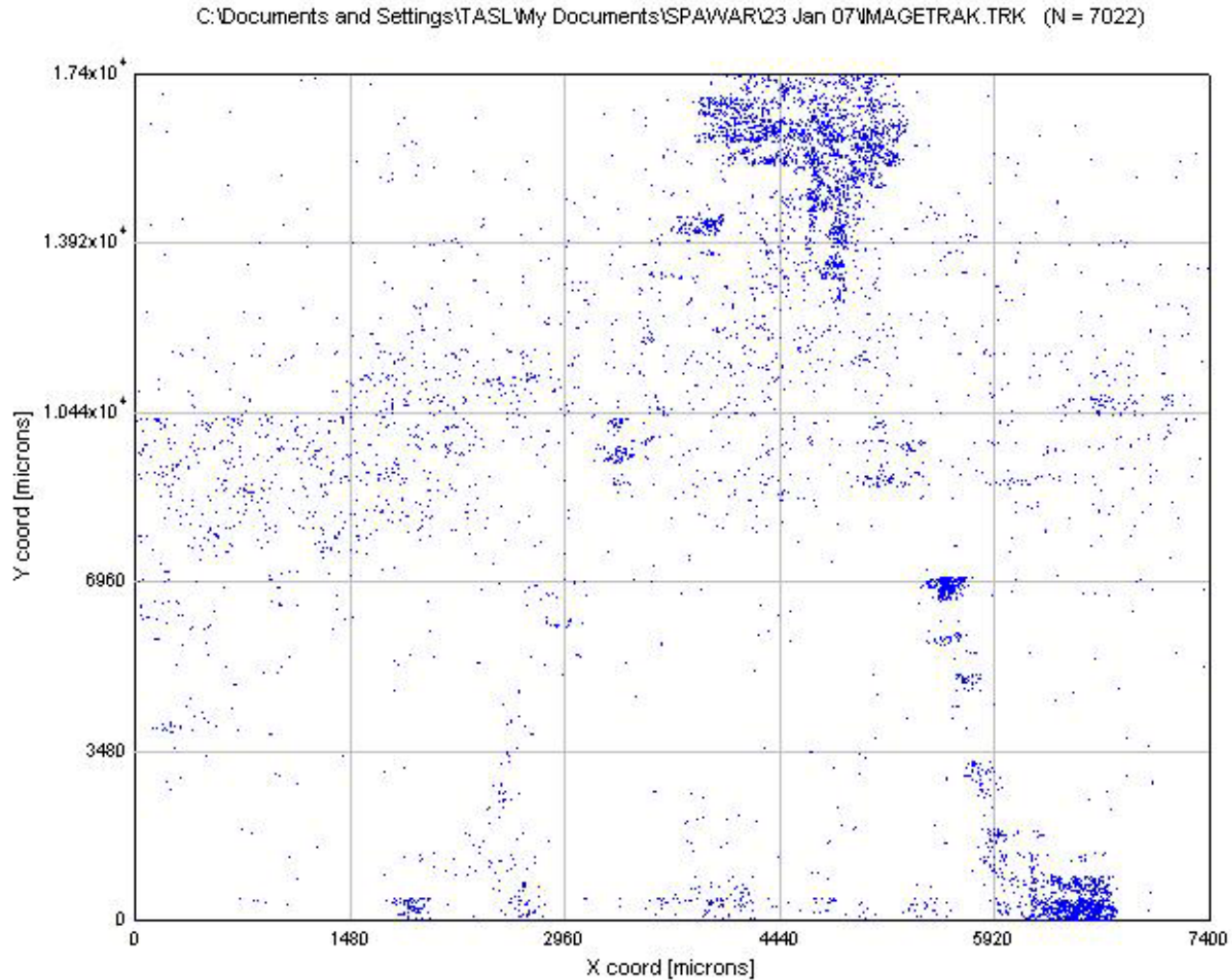


Cathode side of Cell 2

CbottomGrWh.jpg

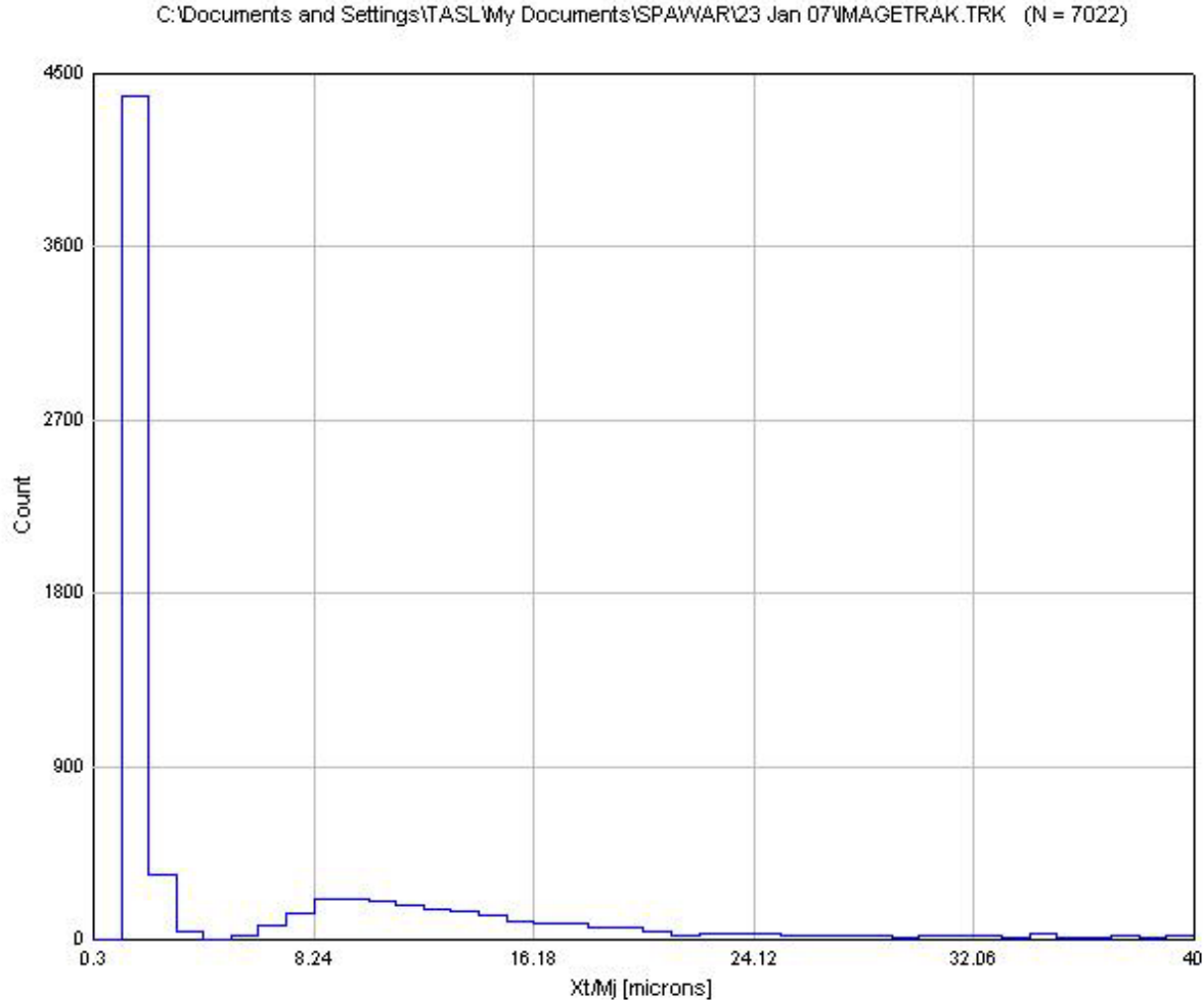
Each image is  $205 \pm 20$  microns wide by  $160 \pm 16$  microns high. Images taken with white light on the "uvscope".

# Scan of front side of CR-39 from Cell 2 (This side was in contact with Ag cathode)



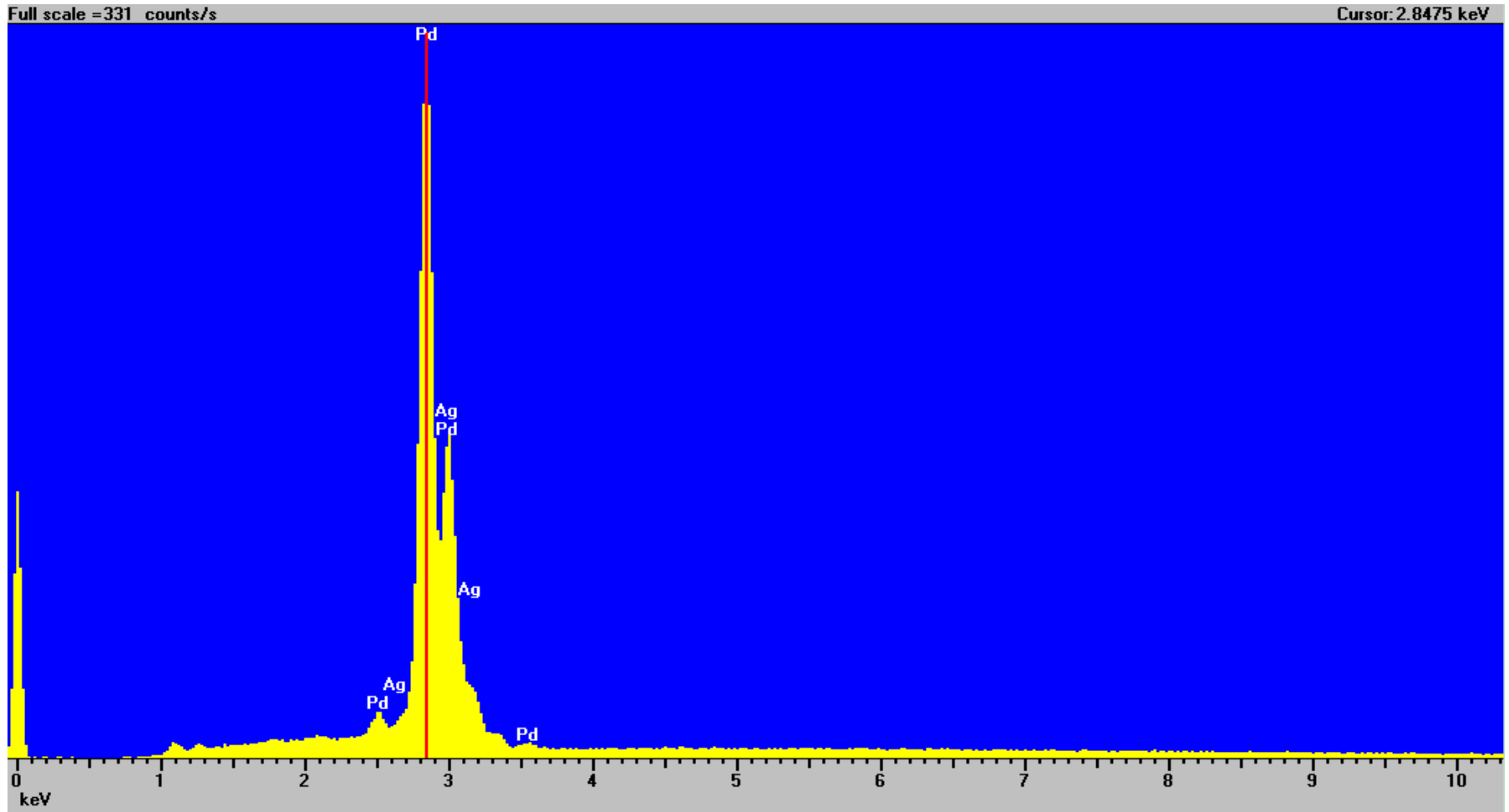
Each blue dot represents the (X, Y) coordinate of an etchpit in microns

# Scan of front side of CR-39 from Cell 2 (This side was in contact with Ag cathode)

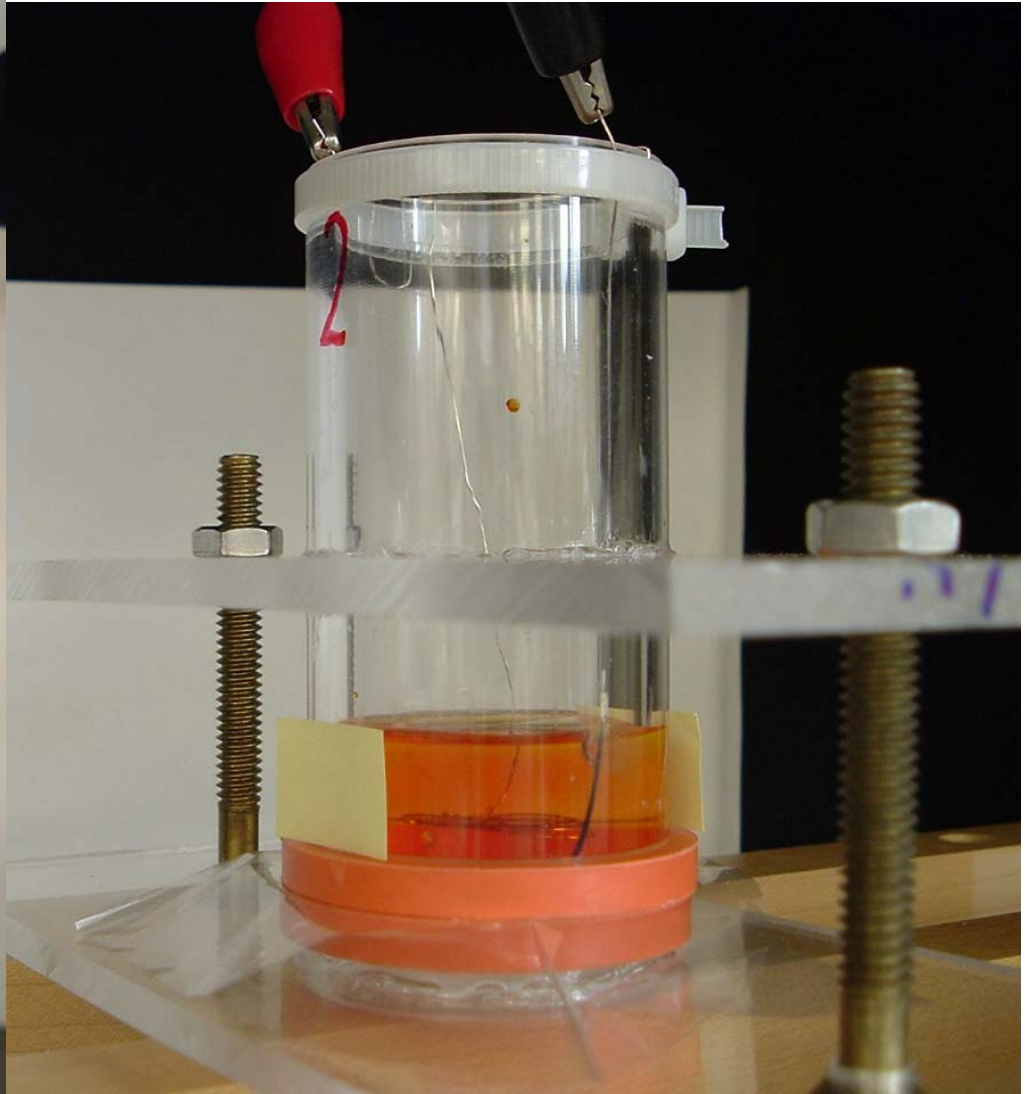


Size distribution of etch pits in microns.

# Electron microprobe spectrum of Pd covered Ag electrode (Cell 2)



# Protecting CR-39 from chemical damage





# Protected CR-39 (initial images)



Above: Am-241 exposed area. Right: two images of tracks in initial survey.

# Acknowledgements

I am deeply grateful to my colleagues, especially Pam Boss and her SPAWAR team for detailed information and support in replicating their co-deposition protocol. Thanks to Larry Forsley and Gary Phillips for scanning my CR-39 samples using their automated microscope.

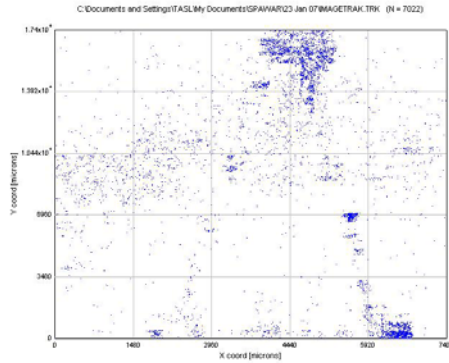
Thanks to Steve Krivit and New Energy Institute for their support with this project.

I also wish to acknowledge John Dash of Portland State University for opening his lab to me in 2005, and for being a living example of research and education to aspire to.

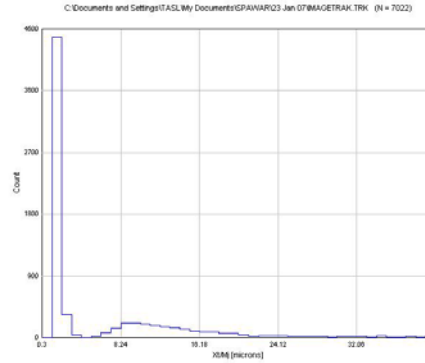


# Summary of next 6 slides: scan data from CR-39 (Only CR-39 from inside Cell 2 has been scanned as of this writing) (Enlarged images are on the following pages)

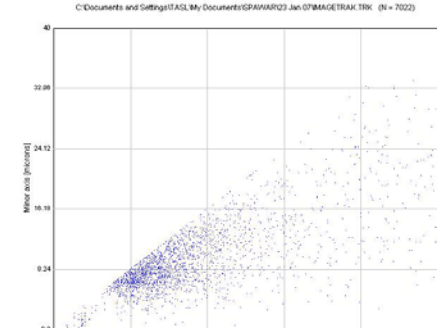
Cathode side



Locations of etch pits

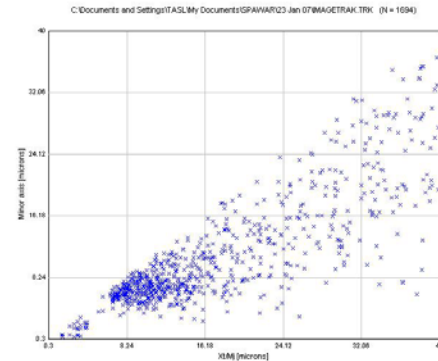
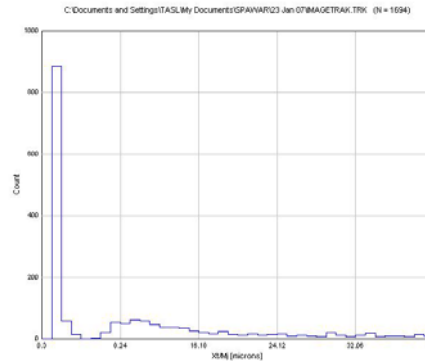
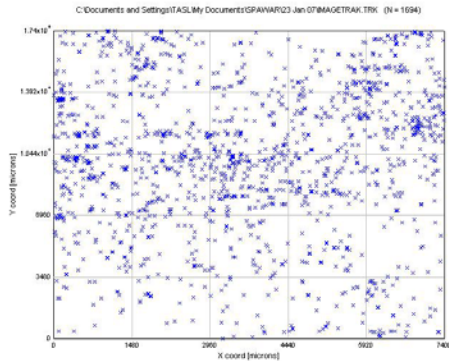


Size distribution of etch pits



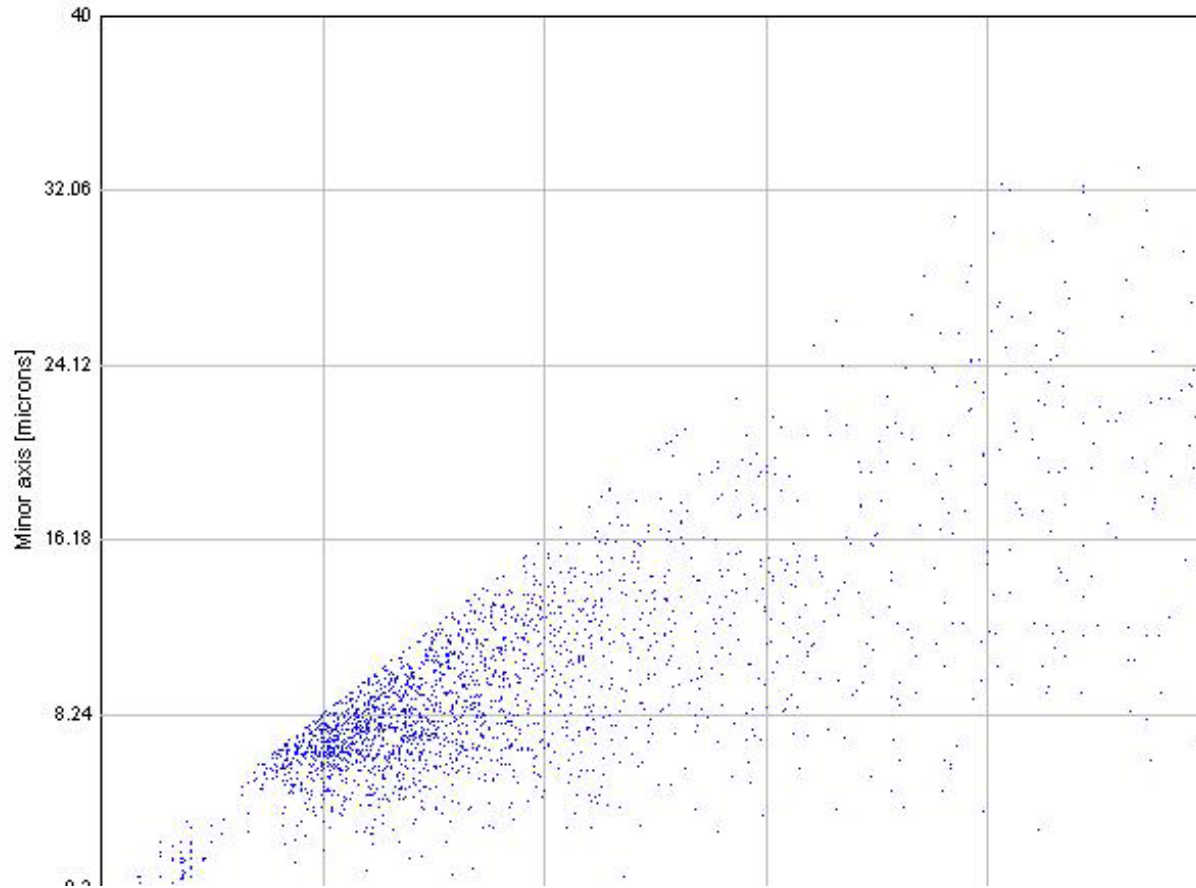
Sizes and shapes of etch pits

Reverse side



# Scan of front side of CR-39 from Cell 2 (This side was in contact with Ag cathode)

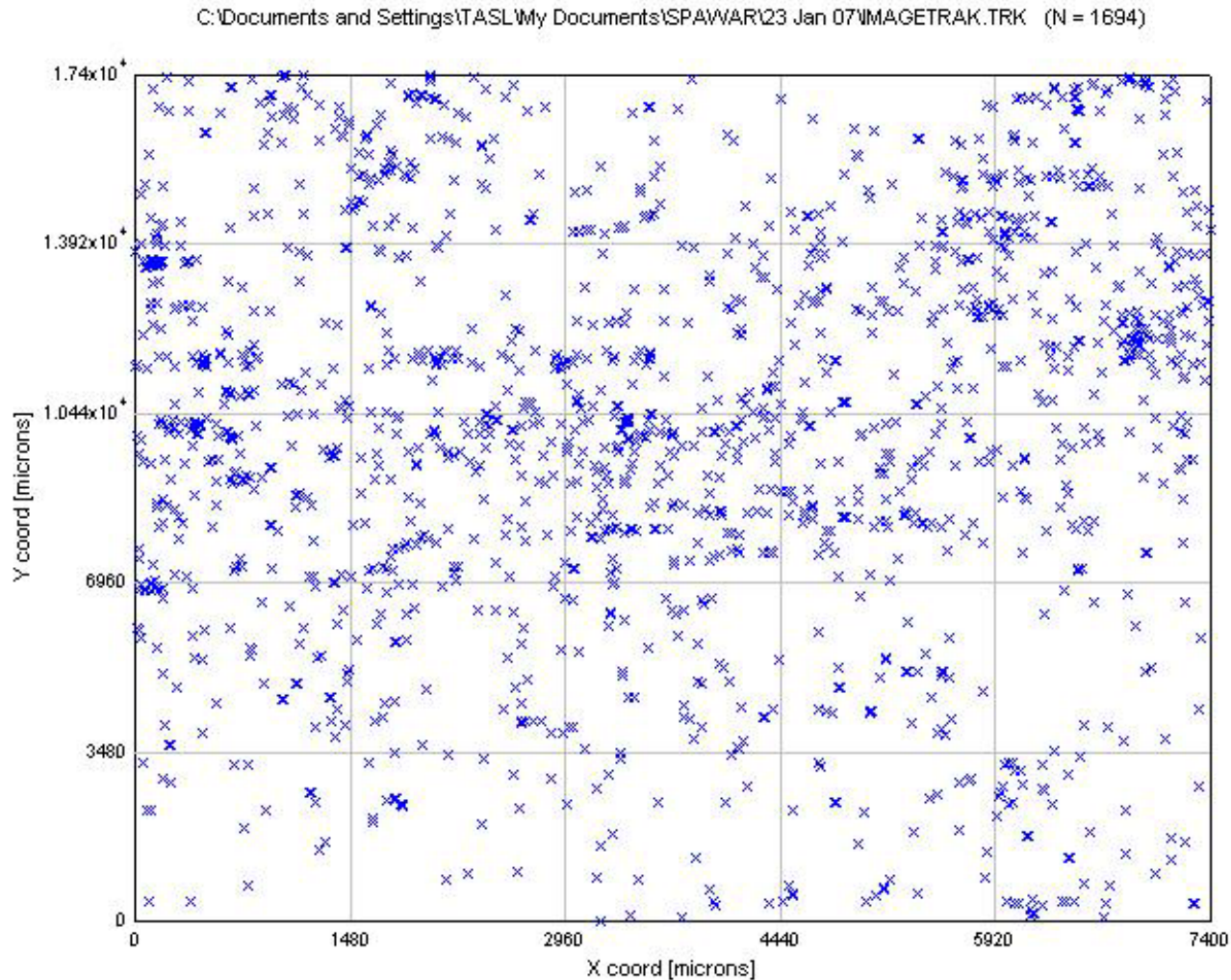
C:\Documents and Settings\TASL\My Documents\SPA\WAR\23 Jan 07\IMAGETRAK.TRK (N = 7022)



Note: bottom  
right of plot  
image was lost

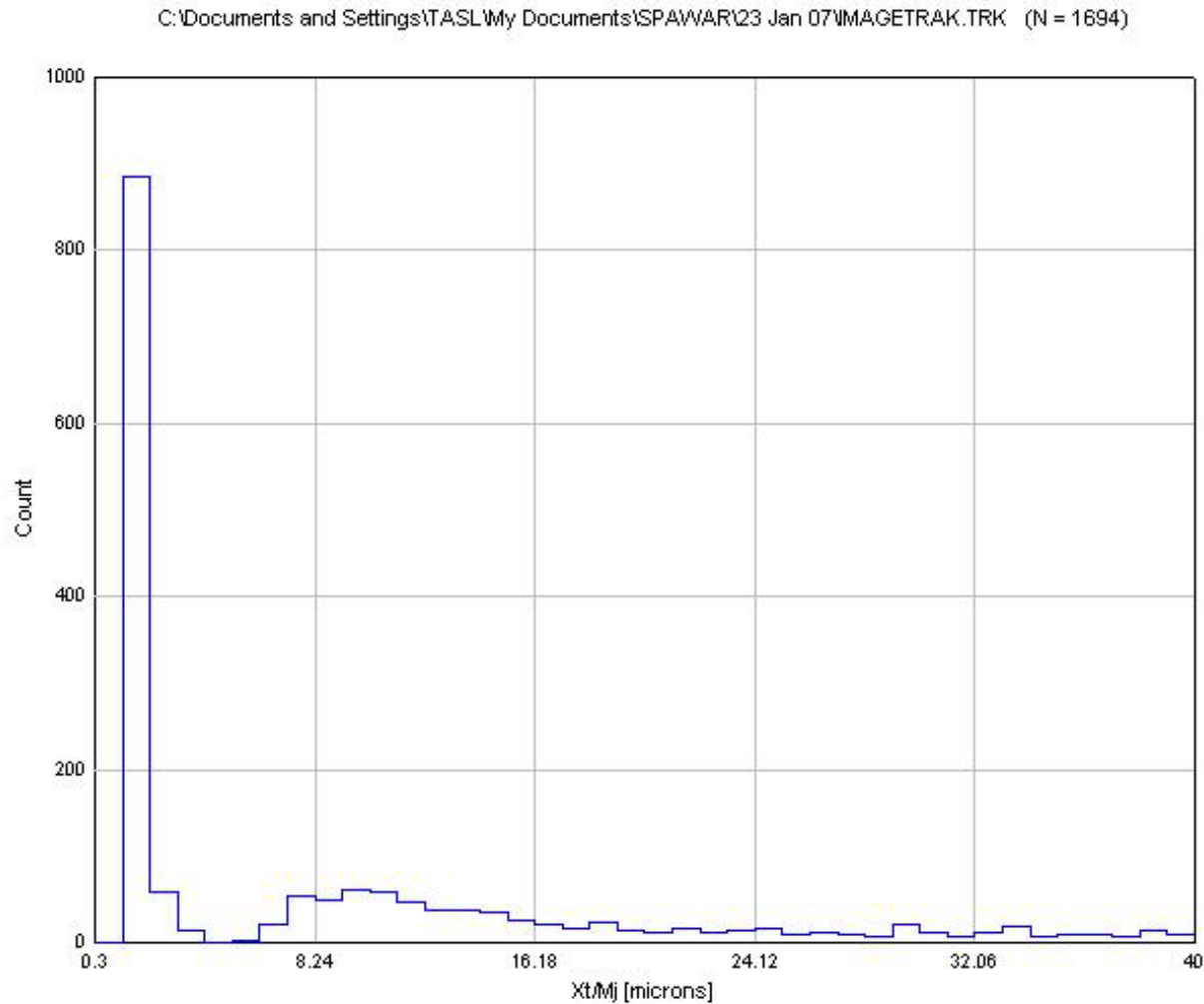
Size and shape distribution of etchpits.

# Scan of back side of CR-39 from Cell 2 (Side not in contact with Ag cathode)



Each blue X represents the (X, Y) coordinate of an etchpit in microns

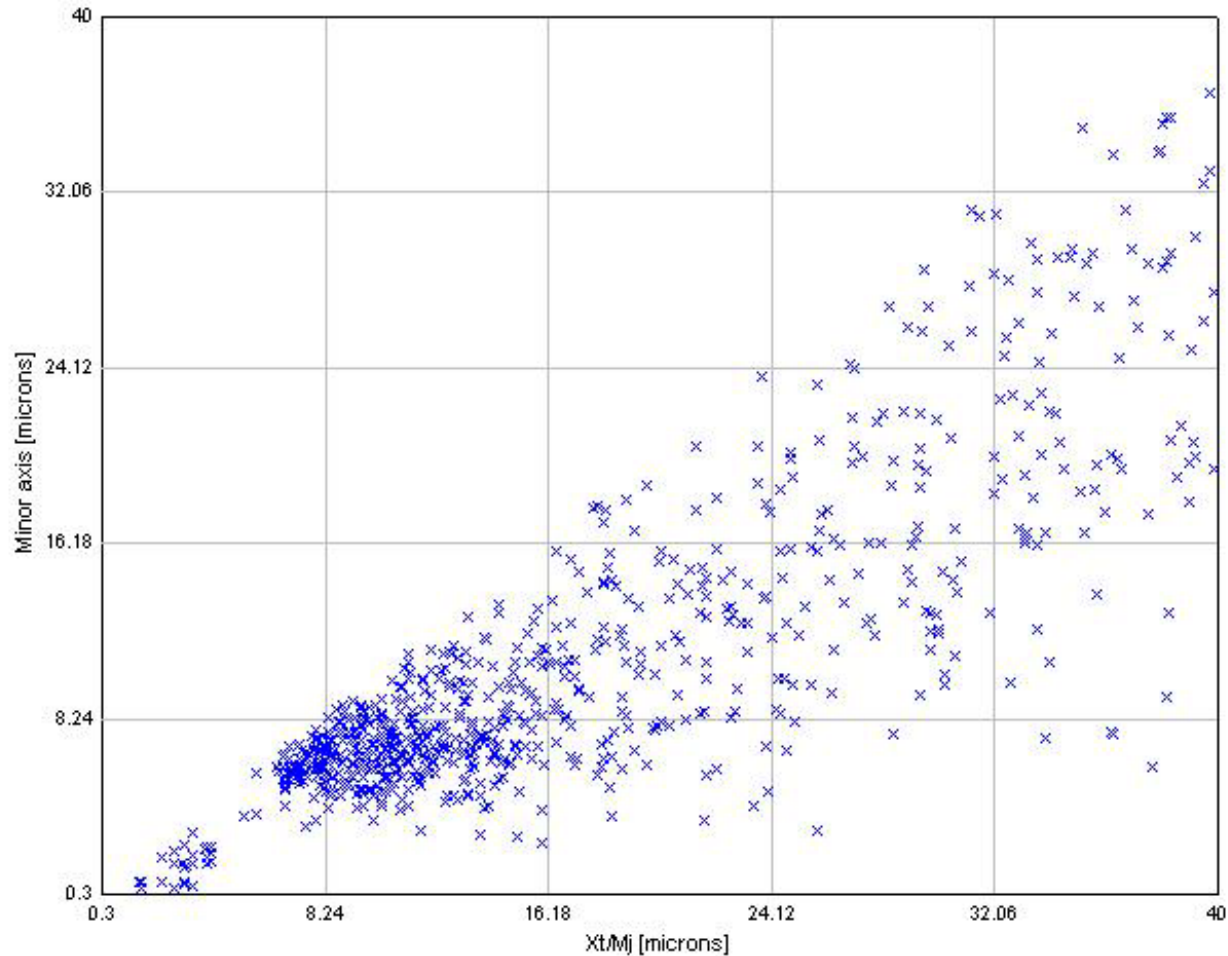
# Scan of back side of CR-39 from Cell 2 (Side not in contact with Ag cathode)



Size distribution of etch pits in microns.

# Scan of back side of CR-39 from Cell 2 (Side not in contact with Ag cathode)

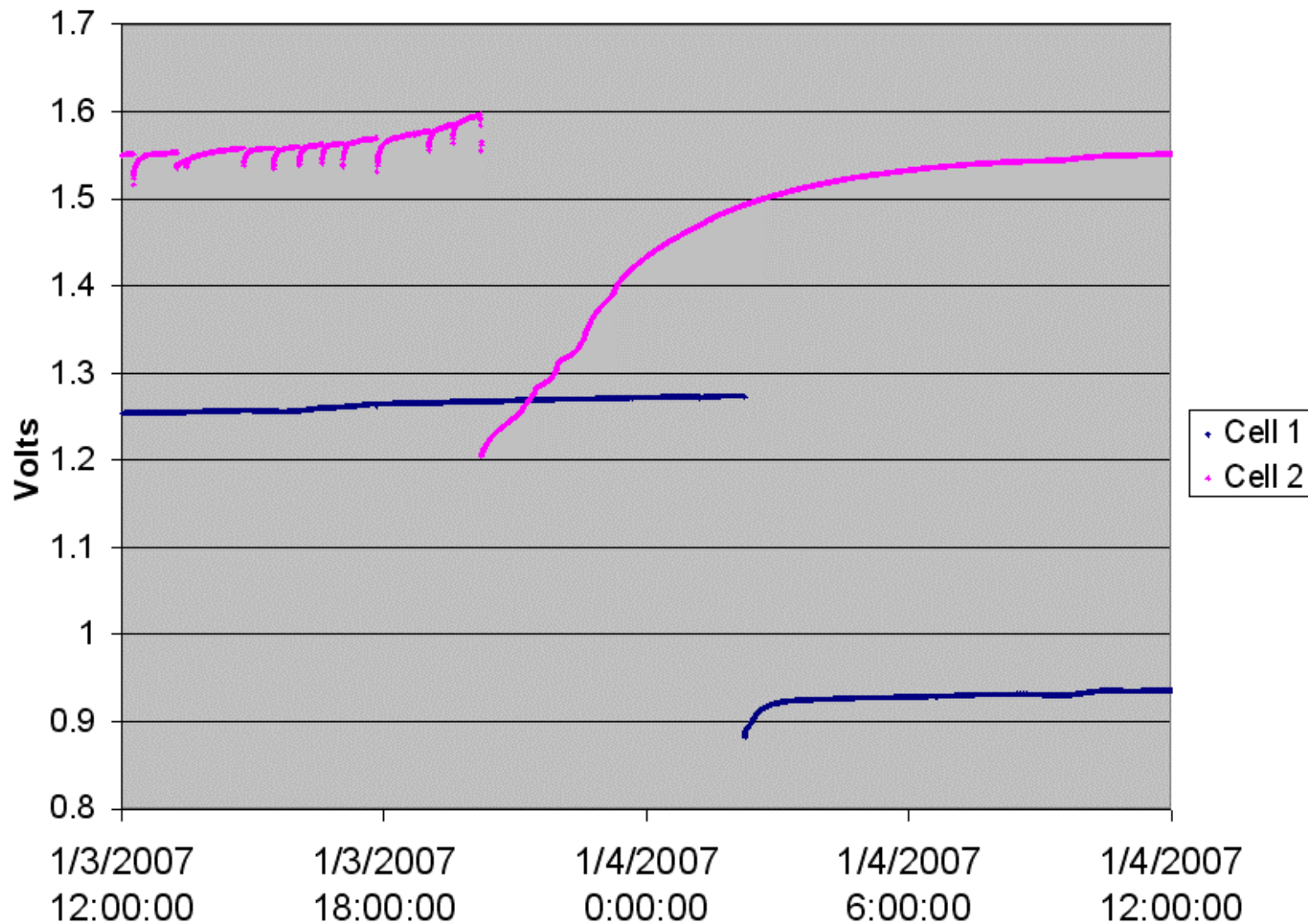
C:\Documents and Settings\TASL\My Documents\SPA\WAR\23 Jan 07\IMAGETRAK.TRK (N = 1694)



Size and shape distribution of etchpits.



The graph below shows the electrolysis voltages, recorded at 6 second intervals, showing sudden drops in potential across each of the two cells. Current was steady at 500 +/- 4 microamps during this entire time.



# Parameters measured for each etchpit

Units are microns except for PHI

One  
etchpit

	X	Y	PHI	RANGE	DIP	MAJ	MIN	XT	ZT	M2
	246.2	2701.3	325.9	0.0	0.0	23.03	18.43	23.03	9.22*	9.22
	214.0	2834.6	249.6	0.0	0.0	13.23	13.23	16.35	15.56*	2.86
	319.4	2950.6	40.8	0.0	0.0	9.60	6.10	8.33*	2.86*	1.24*
	272.3	3545.8	210.4	0.0	0.0	8.52	6.57	7.69*	5.03*	1.14*
	493.8	3391.3	270.0	0.0	0.0	0.82	0.82	1.61	0.63*	0.40
	211.6	3902.4	215.5	0.0	0.0	15.11	7.09	13.32*	1.42*	1.42*
	206.4	3932.8	313.9	0.0	0.0	16.72	16.72	16.72	15.49*	6.39*
	474.1	4138.9	331.3	0.0	0.0	11.19	9.24	11.19*	7.99*	1.73*
	187.9	3925.4	205.3	0.0	0.0	25.09	11.70	25.09*	1.85*	0.57*
...	Etchpit location		Track			Major & minor			Endpoint	Endpoint
			Orient- ation			axes			depth	diameter

(Not sure how much we can trust these two parameters)